In the Specification

On page 2, line 7, replace "apparatuses" with --apparatus--.

On page 2, line 10, replace "apparatuses" with --apparatus--.

On page 8, line 10, following "laser" insert -- beam--.

In the Claims

1! (Amended) A method of bonding [solder] balls of solder to

bond pads on a substrate comprising:

over different respective bond pads on a substrate in the absence of flux; and

with [said] the balls so retained, exposing the balls to bonding conditions effective to bond the balls with their associated bond pads.

2. (Amended) The method of claim 1, wherein [the] exposing [of the balls] comprises laser-bonding the balls.

6

17·

2

3

5

10

11

12

13

14

15

18

19

20

21

22

23